

Engineering Development Model

RF Transformer

TCM2-ED8171/2

Impedance Ratio : 2

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

CASE STYLE : DB714

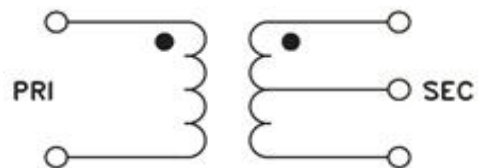
ELECTRICAL SPECIFICATIONS 50Ω @ +25°C				
Parameter		Min.	Typ.	Max. Units
Frequency		0.06		350 MHz
Insertion Loss *	3 dB Bandwidth		0.06 - 350	MHz
	2 dB Bandwidth		0.08 - 250	MHz
	1 dB Bandwidth		0.12 - 150	MHz
Amplitude Unbalance	over 3dB Bandwidth		0.5	dB
	over 1dB Bandwidth		0.1	dB
Phase Unbalance	over 3dB Bandwidth		5.0	deg.
	over 1dB Bandwidth		1.00	deg.

Note:

* Insertion Loss is referenced to mid-band loss, 0.32dB typ.

MAXIMUM RATINGS	
Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.25 W
DC Current	30 mA

Configuration : A

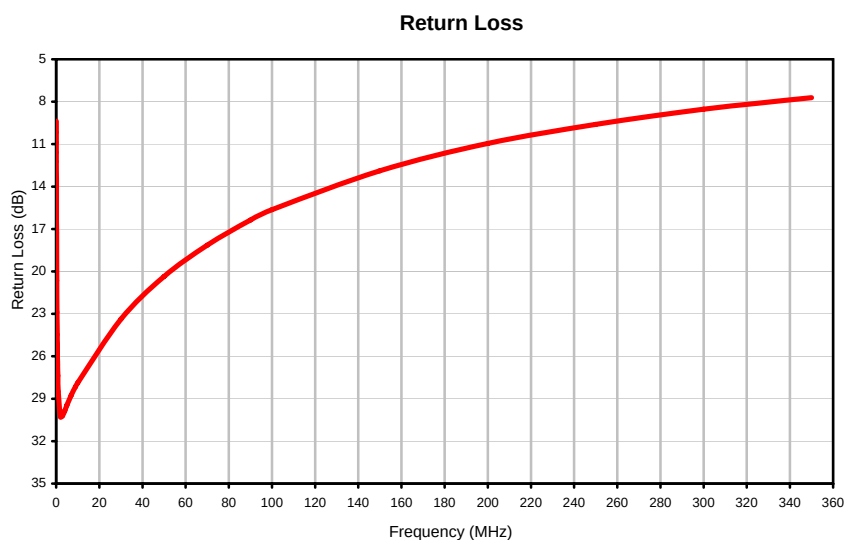


PIN CONNECTIONS	
PRIMARY DOT	1
PRIMARY	3
SECONDARY DOT	6
SECONDARY	4
SECONDARY CT	5
ISOLATE	2

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	RETURN LOSS (dB)
0.06	1.78	9.38
0.07	1.48	10.16
0.08	1.26	10.89
0.09	1.10	11.58
0.10	0.97	12.24
0.12	0.80	13.45
0.14	0.69	14.55
0.16	0.61	15.54
0.18	0.56	16.46
0.20	0.52	17.29
0.30	0.45	20.64
0.40	0.44	22.88
0.50	0.43	24.47
0.60	0.42	25.67
0.70	0.42	26.62
0.80	0.41	27.37
1.00	0.40	28.50
2.00	0.37	30.28
3.00	0.35	30.20
4.00	0.34	29.84
5.00	0.33	29.46
7.00	0.32	28.76
9.00	0.32	28.15
10.00	0.32	27.87
30.00	0.37	23.37
50.00	0.48	20.36
70.00	0.48	18.14
90.00	0.62	16.37
100.00	0.72	15.63
150.00	0.76	12.88
200.00	1.31	10.95
250.00	1.06	9.60
300.00	1.65	8.53
350.00	1.80	7.72

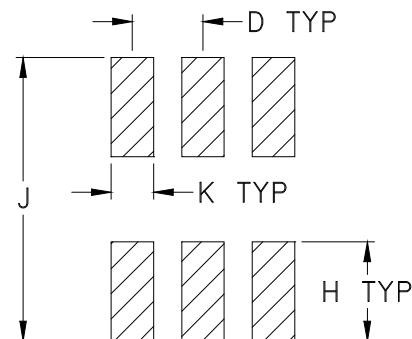
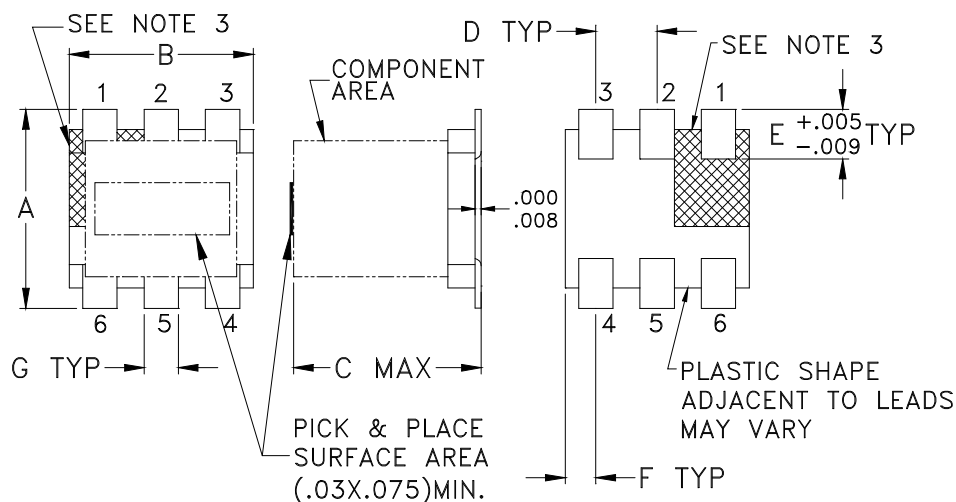
Typical Performance Curves



Outline Dimensions

DB714

PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB714	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- Lead #1 identifier shall be located in the cross-hatched area shown.
Identifier may be either a molded or marked feature.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site

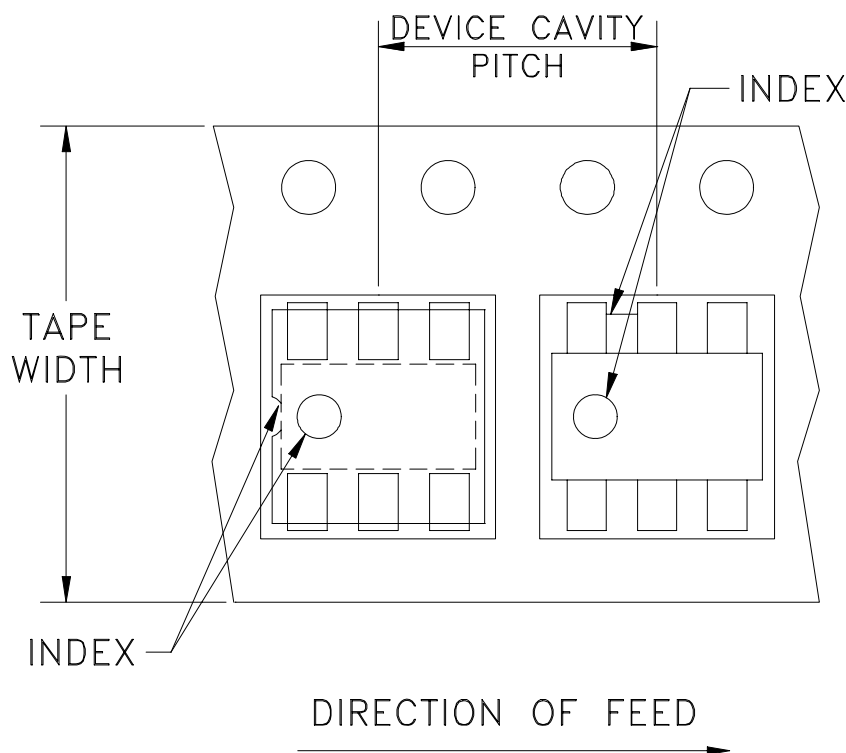


The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



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Mini-Circuits ISO 9001 & ISO 14001 Certified



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215